



US00D816241S

(12) **United States Design Patent**  
**LiCalzi et al.**

(10) **Patent No.:** **US D816,241 S**  
(45) **Date of Patent:** **\*\* Apr. 24, 2018**

(54) **SYSTEM INCLUDING MULTIPLE INSTRUMENT MODULES AND ARRANGEMENT THEREOF**

**DESCRIPTION**

(71) Applicant: **Siemens Healthcare Diagnostics Inc.**, Tarrytown, NY (US)

(72) Inventors: **Daniel LiCalzi**, New York, NY (US); **Youngsang Lee**, Flushing, NY (US); **Robert Faranda**, Boxborough, MA (US); **Richard Watson**, Norwell, MA (US); **Justin Cumming**, Topsfield, MA (US)

(73) Assignee: **Siemens Healthcare Diagnostics Inc.**, Tarrytown, NY (US)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/569,427**

(22) Filed: **Jun. 27, 2016**

(51) **LOC (11) Cl.** ..... **24-01**

(52) **U.S. Cl.**  
USPC ..... **D24/216**

(58) **Field of Classification Search**  
USPC ..... D6/216; D10/46, 70, 81, 97; D24/111, D24/127, 107, 169, 186, 216, 217, 219,  
(Continued)

(56) **References Cited**

U.S. PATENT DOCUMENTS

D645,367 S \* 9/2011 Hayashi ..... D10/81  
D669,189 S \* 10/2012 Liu ..... D24/216  
(Continued)

*Primary Examiner* — Wan Laymon

*Assistant Examiner* — Mark Booker

(57) **CLAIM**

The ornamental design for an system including multiple instrument modules and arrangement thereof, as shown and described.

FIG. 1 is a front perspective view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 2 is a rear perspective view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 3 is a front elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 4 is a rear elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 5 is a left side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 6 is a right side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 7 is a top view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 8 is a bottom view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 9 is a front elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment.

FIG. 10 is a front perspective view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 11 is a front elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 12 is a rear elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 13 is a left side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

FIG. 14 is a right side elevational view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment;

(Continued)

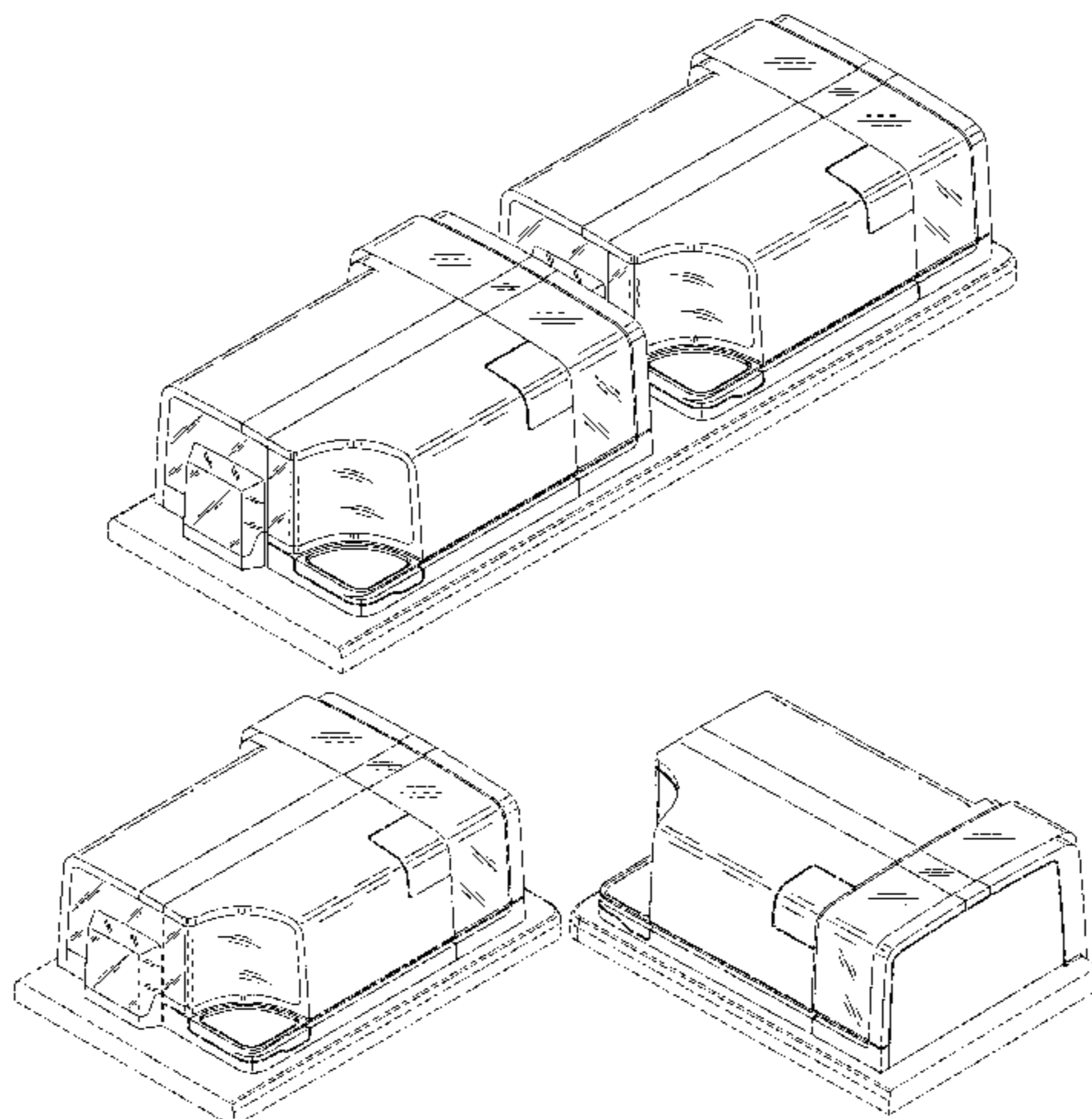


FIG. 15 is a top view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment; and,

FIG. 16 is a bottom view of a system including multiple instrument modules and arrangement thereof in accordance with an embodiment.

The broken lines shown in the figures represent portions of the system including multiple instrument modules and arrangement thereof that form no part of the claimed design. The broken line showing immediately adjacent the shaded areas represents boundaries to the claimed design and forms no part of the claimed design.

**1 Claim, 16 Drawing Sheets**

(58) **Field of Classification Search**

USPC ..... D24/223-224, 231-234; 422/1, 62-65, 422/67, 68.1, 70, 81, 129, 500, 506, 561,

422/FOR. 106; 435/287.1, 287.3;  
436/43, 45, 47; 600/300, 301, 368, 372,  
600/481, 529, 544, 554, 561; 607/4, 5, 9,  
607/30

CPC ... G01R 31/31907; B04B 13/00; B04B 15/00;  
B04B 2005/0435; B04B 5/0421; A61B  
5/157; G06F 19/366; B01D 21/262

See application file for complete search history.

(56)

**References Cited**

U.S. PATENT DOCUMENTS

D676,143 S \* 2/2013 Liu ..... D24/216  
D676,568 S \* 2/2013 Liu ..... D24/216  
D685,483 S \* 7/2013 LiCalzi ..... D24/216  
D735,878 S \* 8/2015 Chang ..... D24/216  
D738,243 S \* 9/2015 Selberg ..... D10/81

\* cited by examiner

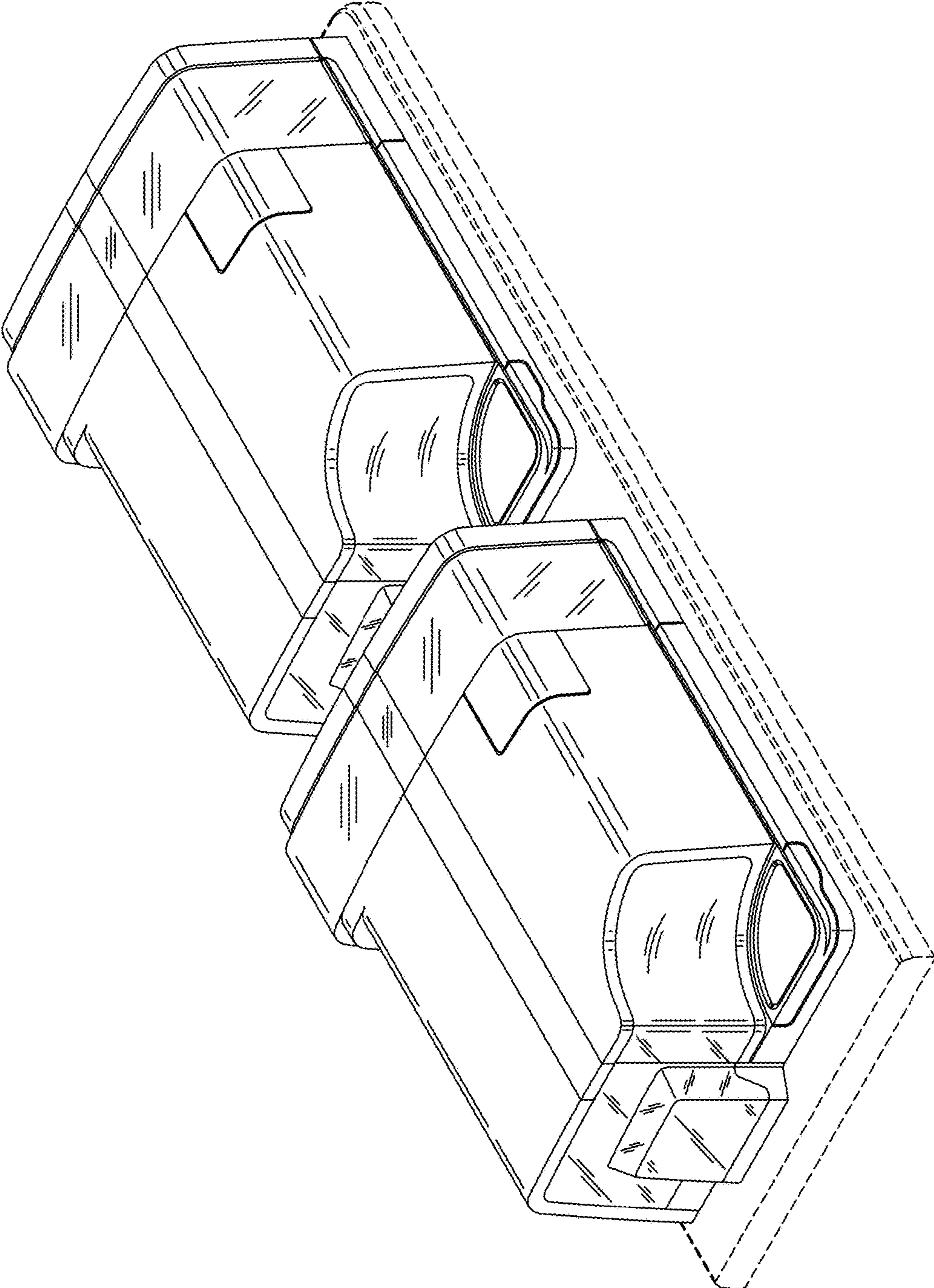


FIG. 1

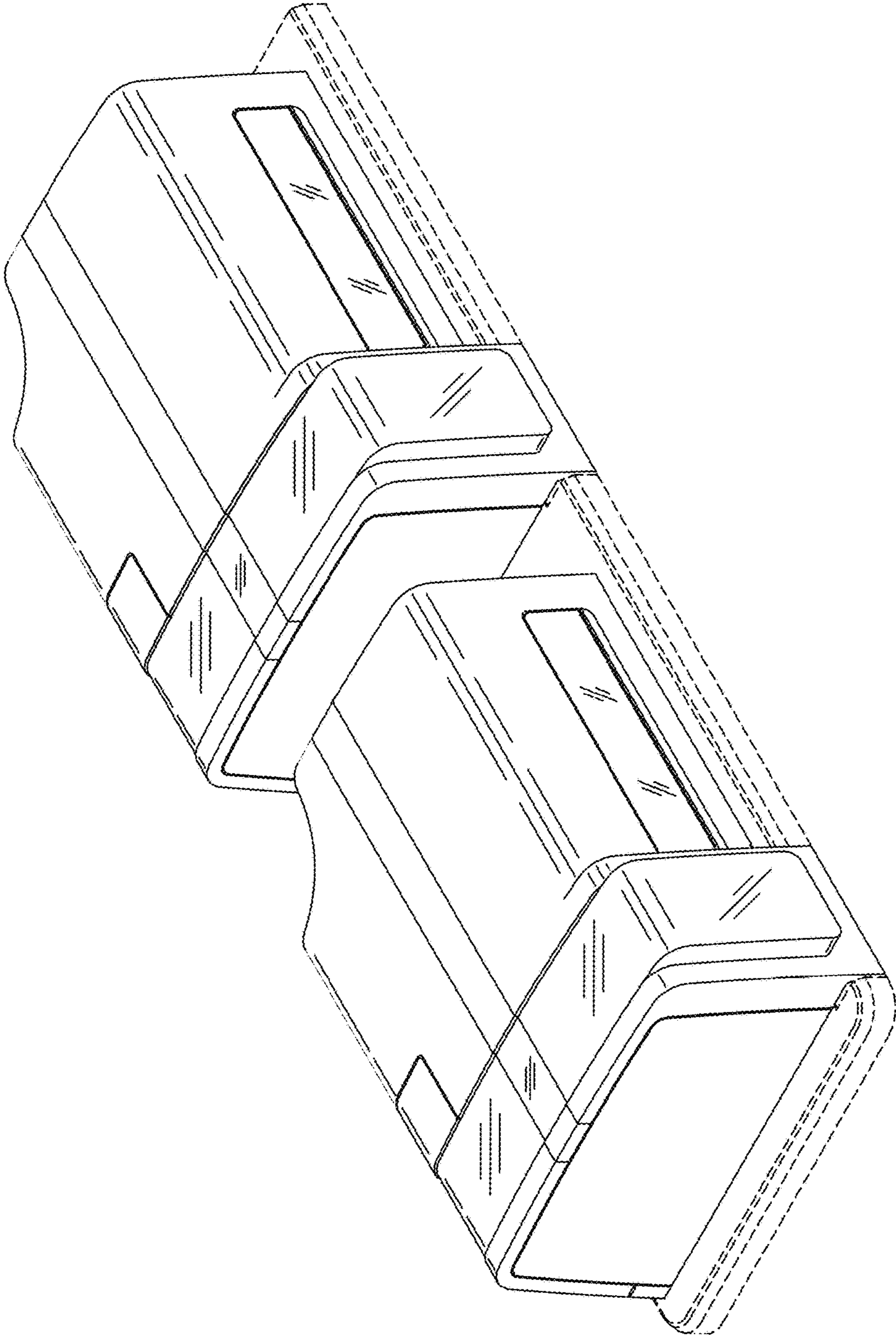


FIG. 2

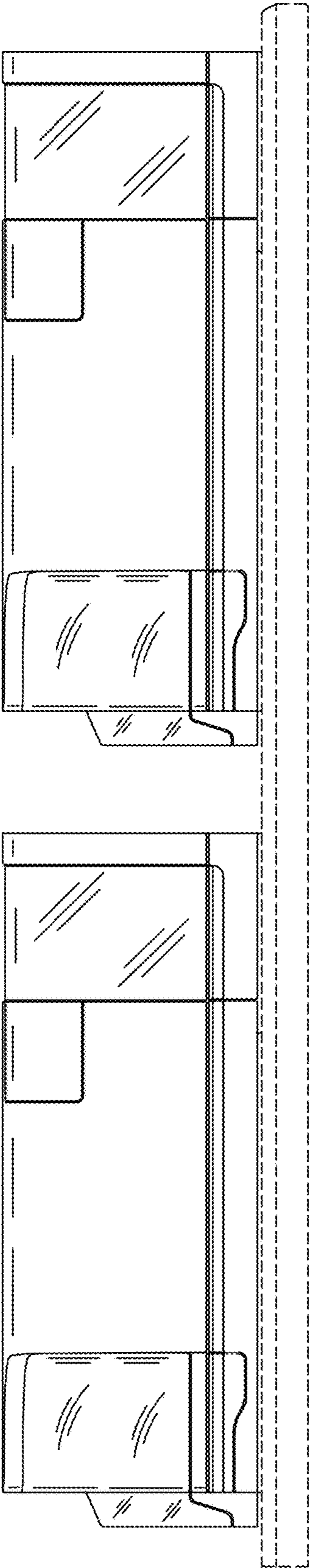


FIG. 3

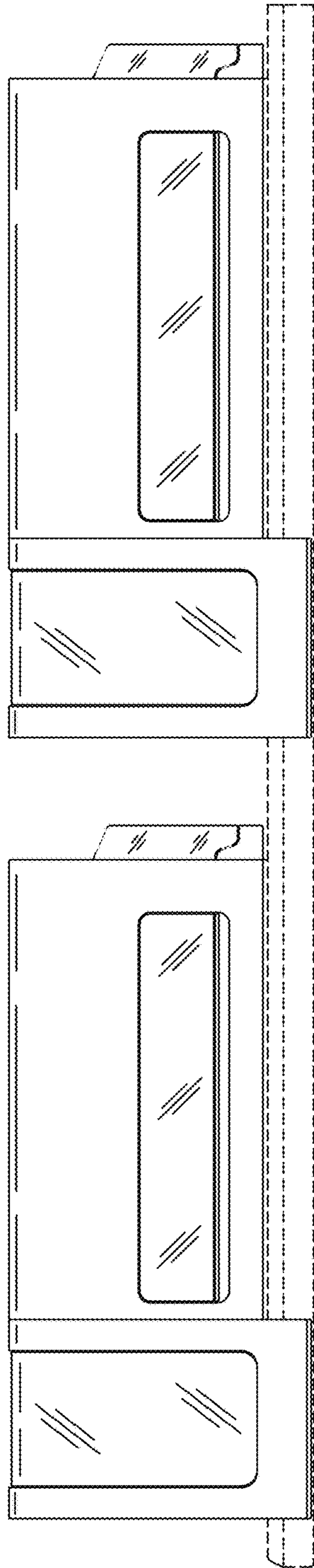


FIG. 4

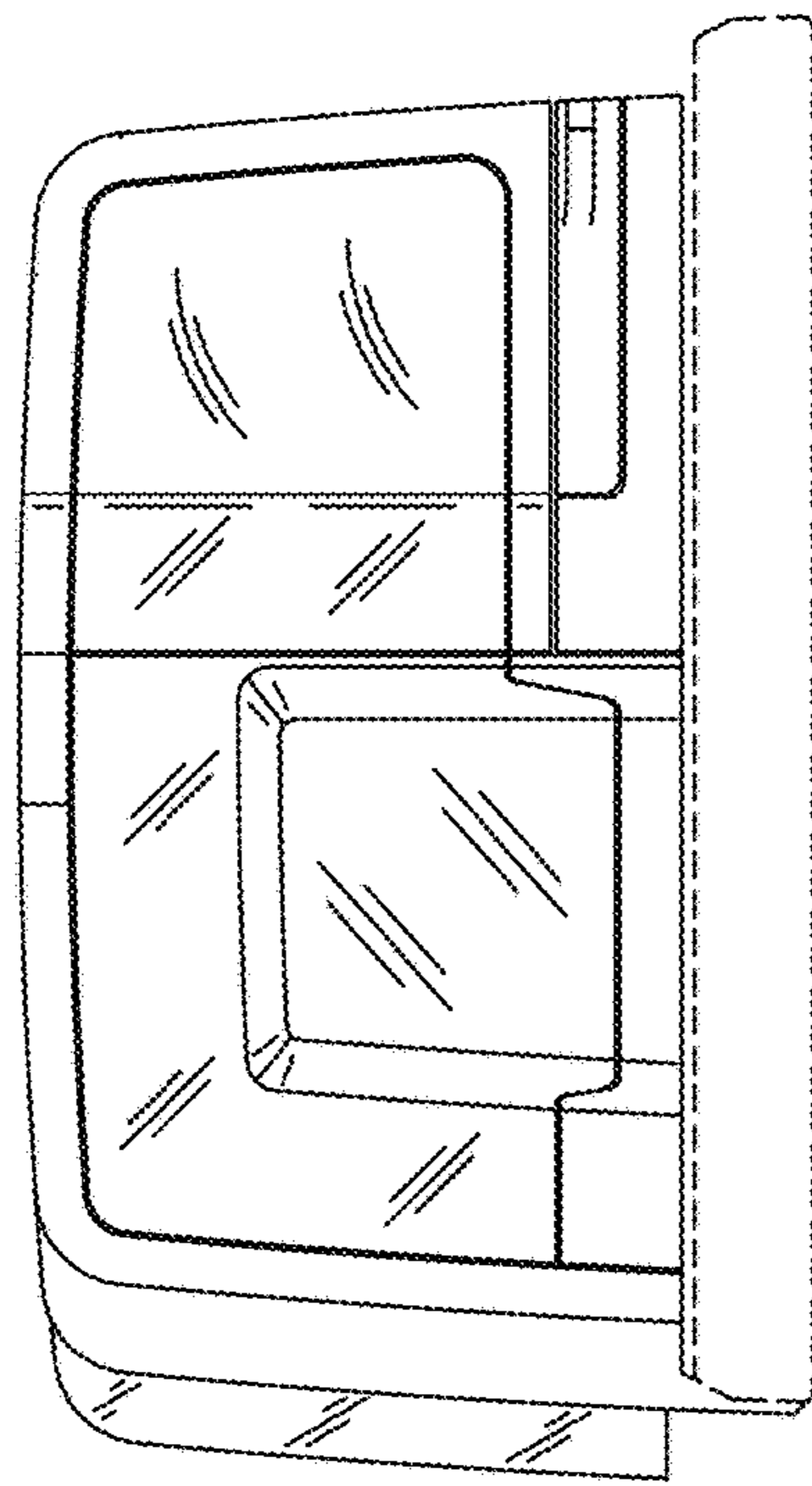


FIG. 5

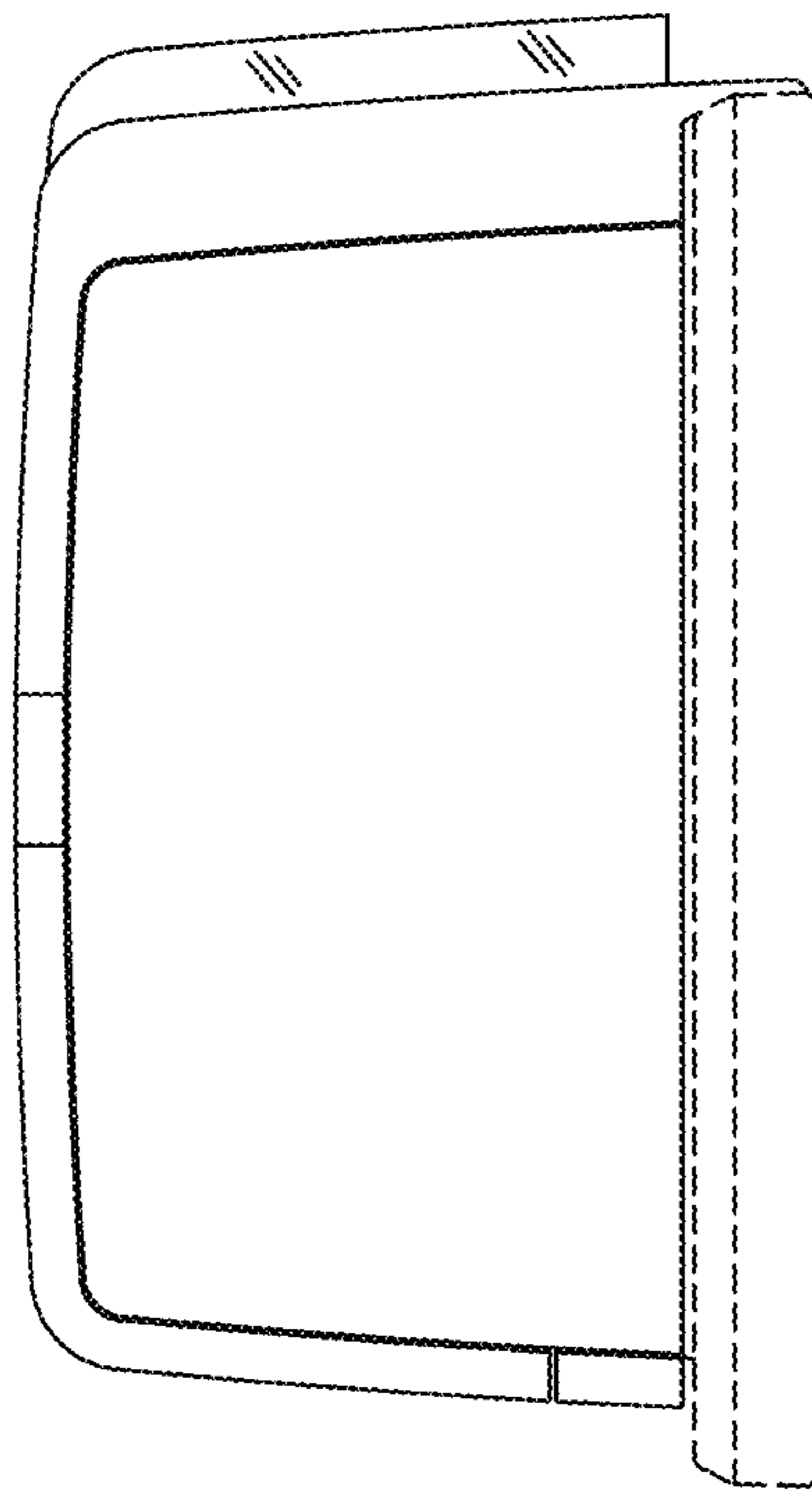


FIG. 6



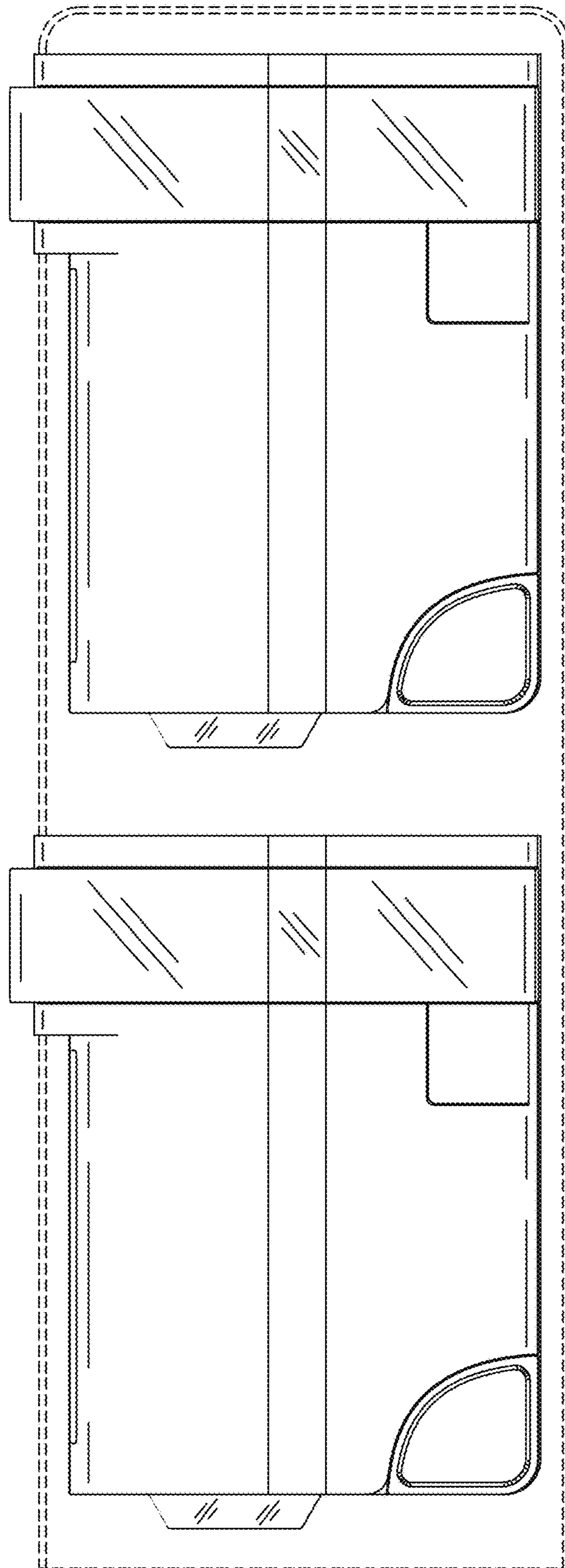


FIG. 7

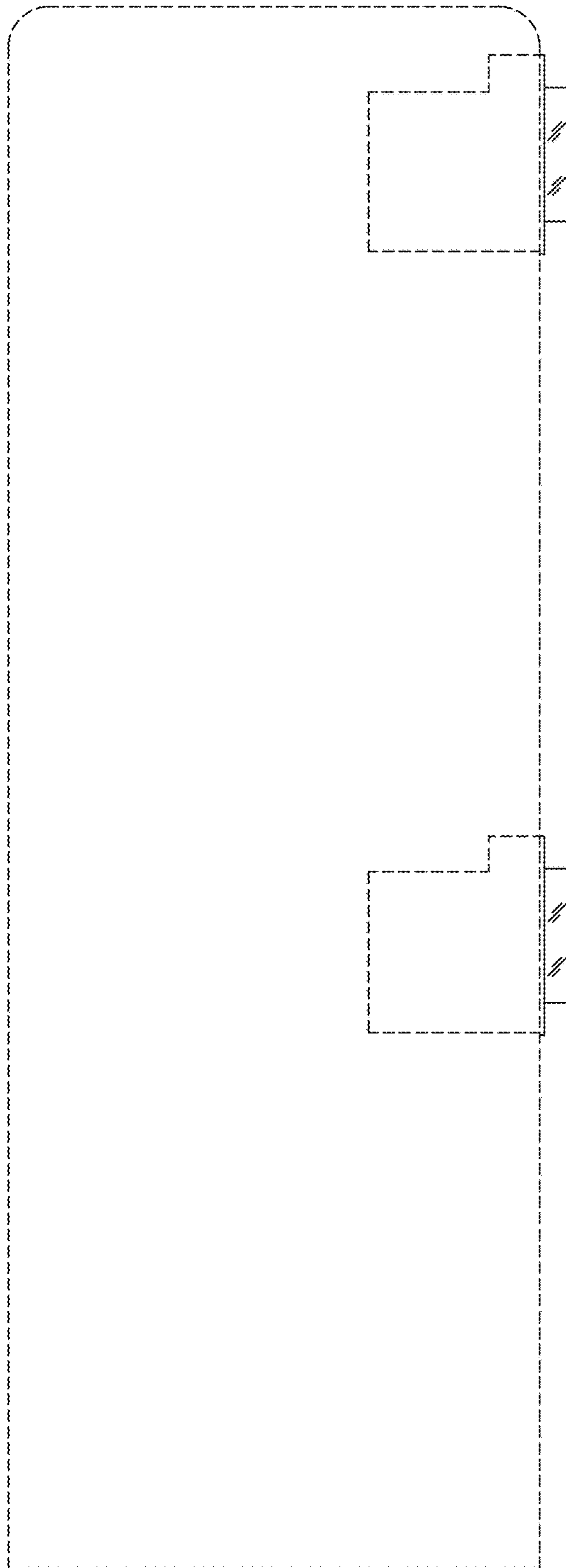


FIG. 8

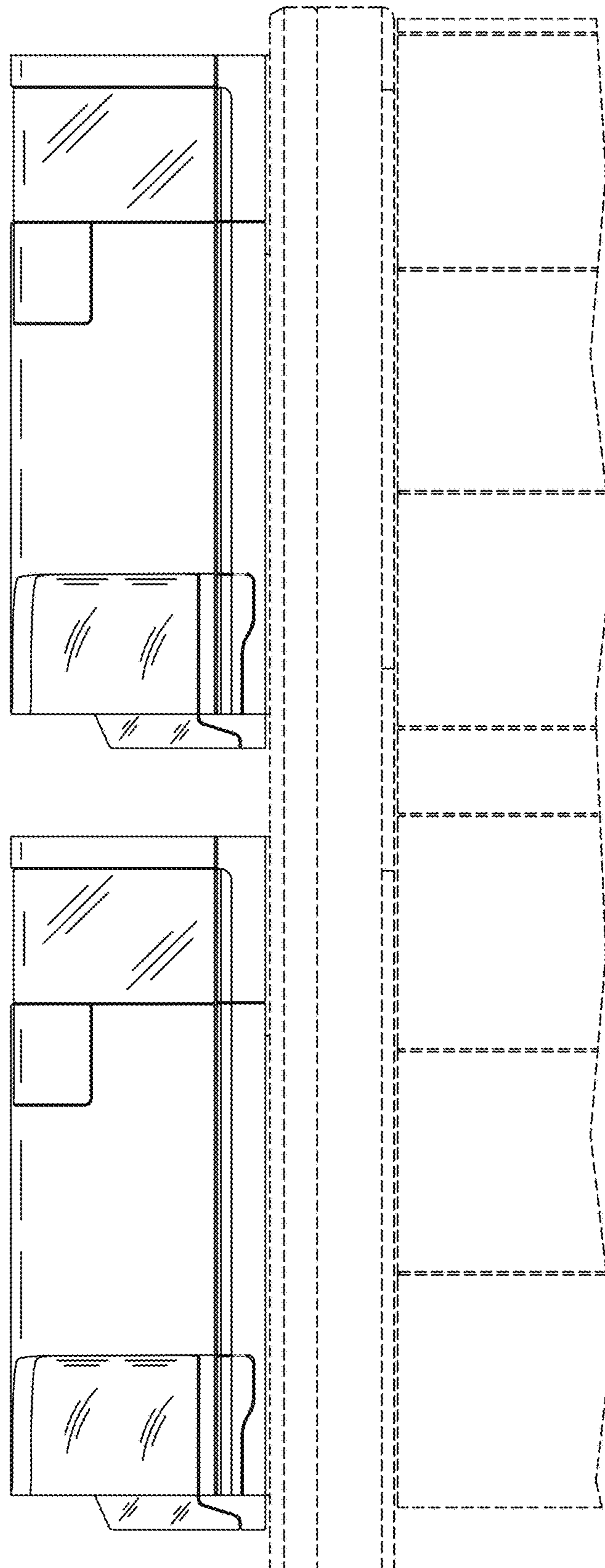


FIG. 9

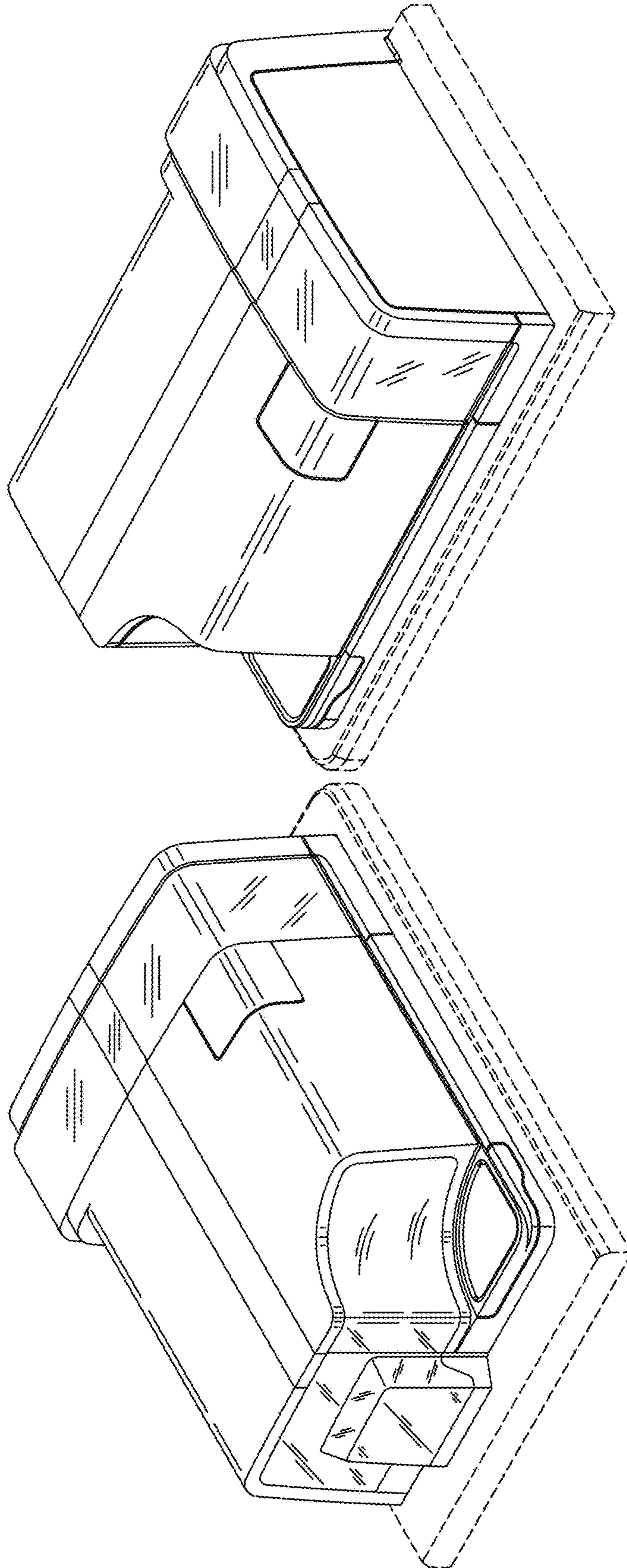


FIG. 10

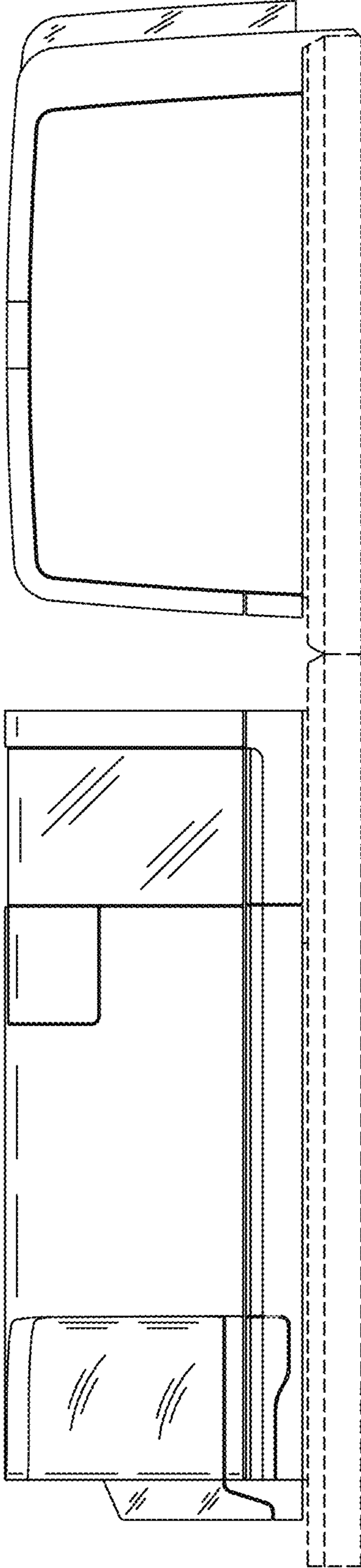


FIG. 11

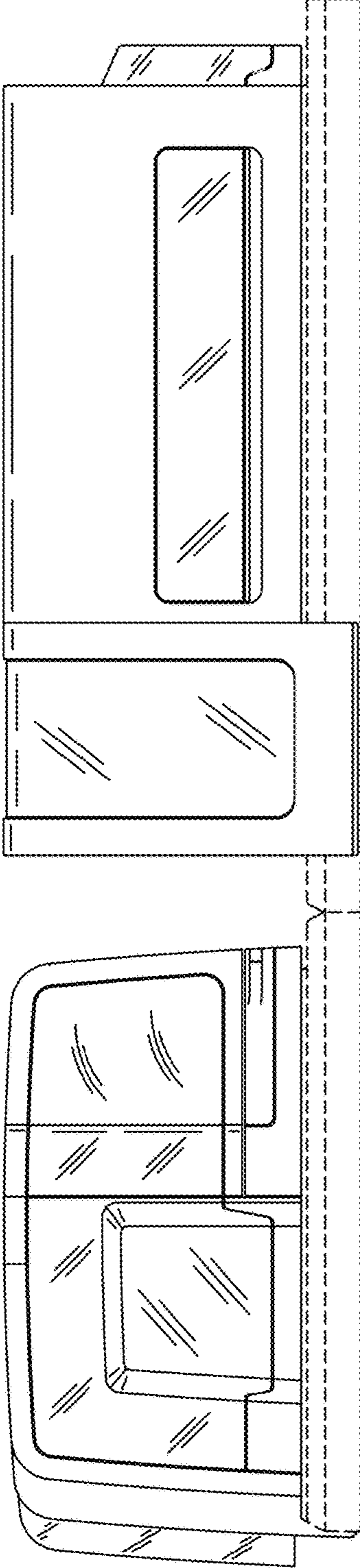


FIG. 12

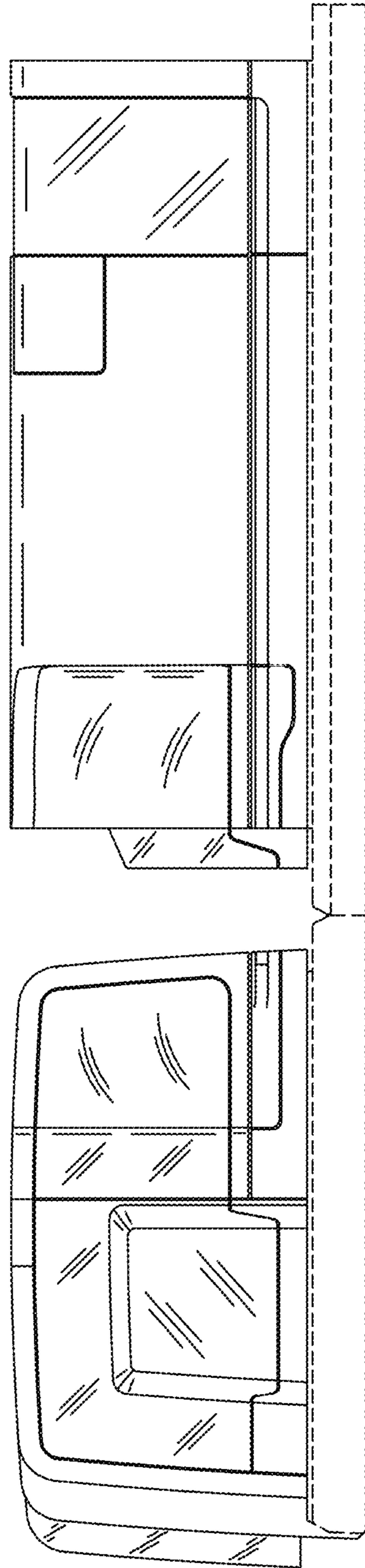


FIG. 13

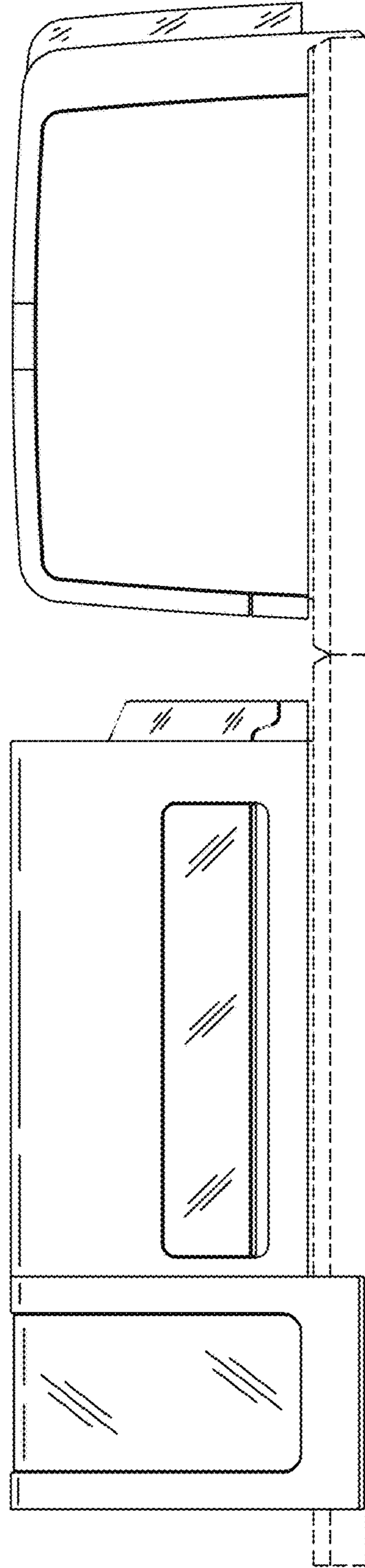


FIG. 14



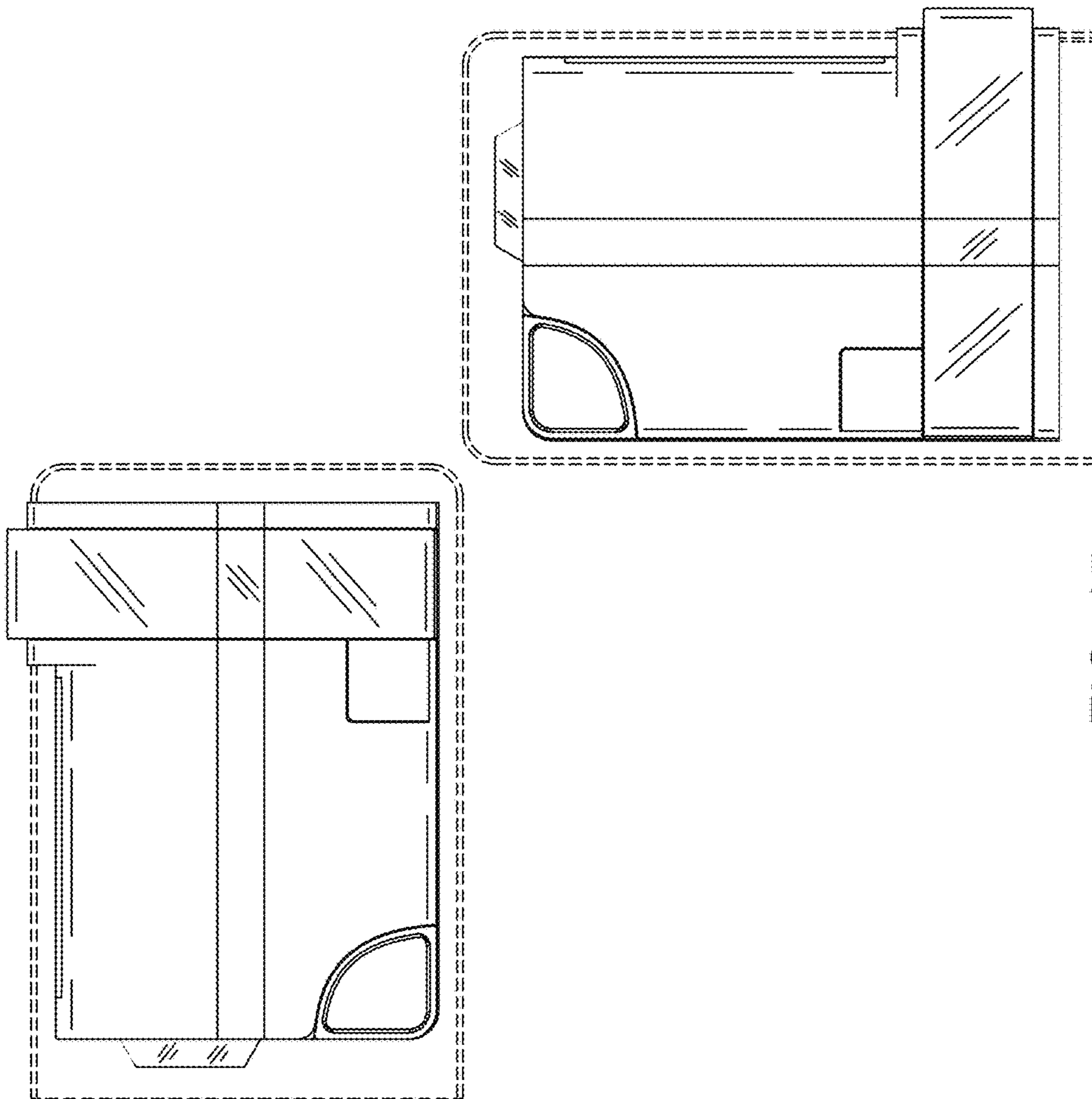


FIG. 15

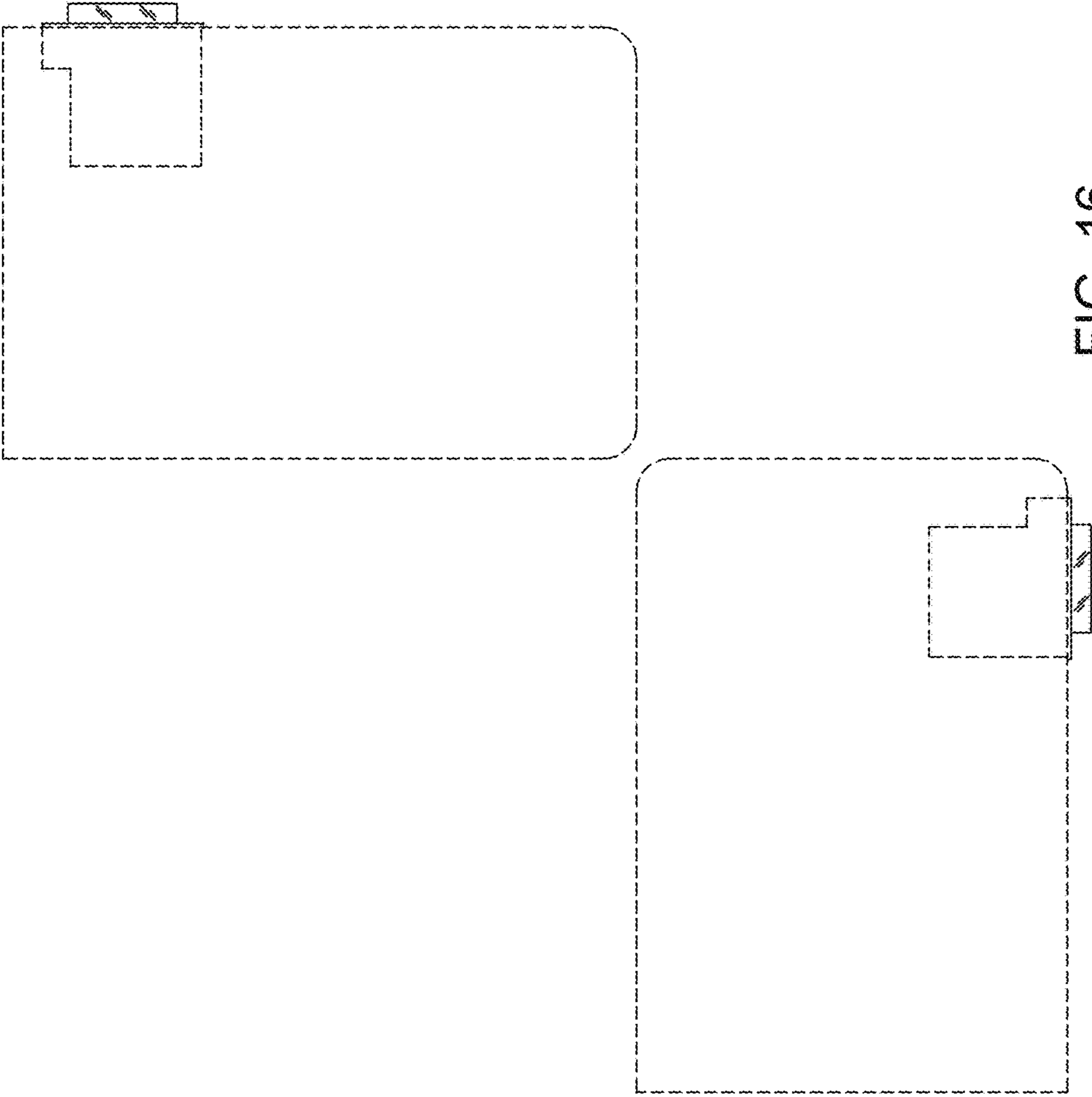


FIG. 16